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(a) The execution date(s) of the application is/are:
(b) The title is: APPARATUS AND METHOD FOR BALANCING LOAD IN MULTI-CORE
PROCESSOR SYSTEM
OR
☒ This document is being filed after filing of the application:
(a) Patent Application No(s). 11/832,732, filed August 2, 2007; or
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5. Name and address of party to whom correspondence concerning document should be mailed:
STEIN, MCEWEN & BUI, LLP Our Docket: 0007.1083
Attention: Hung H. Bui
1400 Eye St., N.W., Suite 300
Washington, D.C. 20005
6. Total number of applications and patents involved: 1
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